

<b>flow PIM 2</b>		<b>600 V / 100 A</b>
<b>Features</b> <ul style="list-style-type: none"> <li>Three-phase rectifier, BRC, Inverter, NTC</li> <li>Very Compact housing, easy to route</li> <li>IGBT3/ EmCon3 technology for low saturation losses and improved EMC behavior</li> </ul>		
<b>Target Applications</b> <ul style="list-style-type: none"> <li>Motor Drives</li> <li>Power Generation</li> </ul>		
<b>Types</b> <ul style="list-style-type: none"> <li>V23990-P765-A-PM</li> <li>V23990-P765-AY-PM</li> </ul>		
<b>Schematic</b>		
<b>flow 2 17mm housing</b>		

## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Input Rectifier Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1600	V
Forward current	$I_{FAV}$		100	A
Surge (non-repetitive) forward current	$I_{FSM}$	$t_p = 10 \text{ ms}$	1000	A
I <sup>2</sup> t-value	$I^2t$		5000	$\text{A}^2\text{s}$
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	130	W
Maximum Junction Temperature	$T_{jmax}$		150	$^\circ\text{C}$
<b>Inverter Switch</b>				
Collector-emitter breakdown voltage	$V_{CE}$		600	V
DC collector current	$I_C$		100	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	200	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	216	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15 \text{ V}$	6 360	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$



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## Maximum Ratings

 $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Inverter Diode</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$	$T_j = T_{jmax}$	80	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	200	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	131	W
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$
<b>Brake Switch</b>				
Collector-emitter breakdown voltage	$V_{CE}$		600	V
DC collector current	$I_C$		75	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	225	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	141	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15\text{ V}$	6 360	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$
<b>Brake Inverse Diode</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$		20	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	40	A
Brake Inverse Diode	$P_{tot}$	$T_j = T_{jmax}$	55	W
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$
<b>Brake Diode</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$		30	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	90	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	67	W
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$
<b>Thermal properties</b>				
Storage temperature	$T_{stg}$		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	$T_{op}$		-40...+ $T_{jmax}$ -25	$^\circ\text{C}$
<b>Isolation Properties</b>				
Isolation voltage	$V_{isol}$	DC Test Voltage*	$t_p = 2\text{ s}$	4000
		AC Voltage	$t_p = 1\text{ min}$	2500
Creepage distance				min 12,7
Clearance		with Press-fit pins / with Solder pins		11,58 / 11,82
Comparative Tracking Index	CTI			>200

\* 100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
		$V_{GE}$ [V]	$V_r$ [V]	$I_c$ [A]	$T_j$ [°C]	Min	Typ	Max			
		$V_{GS}$ [V]	$V_{CE}$ [V]	$I_F$ [A]	$I_D$ [A]						
<b>Input Rectifier Diode</b>											
Forward voltage	$V_F$			100	25 125			1,2 1,16	1,9	V	
Threshold voltage (for power loss calc. only)	$V_{to}$				25 125			0,91 0,77		V	
Slope resistance (for power loss calc. only)	$r_t$				25 125			0,003 0,004		Ω	
Reverse current	$I_r$		1500		25 125				0,05 1,1	mA	
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,52		K/W	
<b>Inverter Switch</b>											
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$		0,0016	25	5	5,8	6,5		V	
Collector-emitter saturation voltage	$V_{CESat}$		15	100	25 150			1,48 1,73	2,2	V	
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	600	25				0,25	mA	
Gate-emitter leakage current	$I_{GES}$		20	0	25				700	nA	
Integrated Gate resistor	$R_{gint}$						none			Ω	
Turn-on delay time	$t_{d(on)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	$\pm 15$	300	100	25 150		137 138		ns	
Rise time	$t_r$					25 150		16 19			
Turn-off delay time	$t_{d(off)}$					25 150		188 217			
Fall time	$t_f$					25 150		84 104			
Turn-on energy loss	$E_{on}$					25 150		0,54 0,93		mWs	
Turn-off energy loss	$E_{off}$					25 150		2,5 3,48			
Input capacitance	$C_{ies}$							6280			
Output capacitance	$C_{oss}$	$f = 1 \text{ MHz}$	$0$	25	25			400		pF	
Reverse transfer capacitance	$C_{rss}$							108			
Gate charge	$Q_G$					$\pm 15$	480	100	25	nC	
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,44		K/W	
<b>Inverter Diode</b>											
Diode forward voltage	$V_F$			100	25 150			1,62 1,63	2,3	V	
Peak reverse recovery current	$I_{RRM}$	$R_{gon} = 4 \Omega$	$\pm 15$	300	100	25 150		128 152		A	
Reverse recovery time	$t_{rr}$					25 150		106 127		ns	
Reverse recovered charge	$Q_{rr}$					25 150		4,64 9,2		μC	
Peak rate of fall of recovery current	$(di_{rd}/dt)_{max}$					25 150		9459 5303		A/μs	
Reverse recovered energy	$E_{rec}$					25 150		1,13 2,25		mWs	
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,73		K/W	



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V23990-P765-AY-PM

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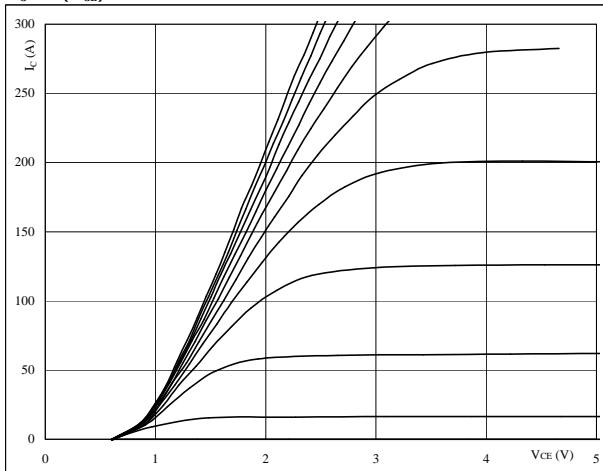
## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_r$ [V]	$I_c$ [A]	$I_F$ [A]	$T_j$ [ $^{\circ}$ C]	Min	Typ	Max	
<b>Brake Switch</b>											
Gate emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE} = V_{GE}$			0,0012	25		5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		15		75	25 150			1,45 1,69	2,1	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	600		25				0,66	mA
Gate-emitter leakage current	$I_{GES}$		20	0		25				700	nA
Integrated Gate resistor	$R_{\text{gint}}$								none		$\Omega$
Turn-on delay time	$t_{d(\text{on})}$	$R_{\text{goff}} = 4 \Omega$ $R_{\text{gon}} = 4 \Omega$	$\pm 15$	300	75	25 150			111 113		ns
Rise time	$t_r$					25 150			12 15		
Turn-off delay time	$t_{d(\text{off})}$					25 150			173 202		
Fall time	$t_f$					25 150			53 74		
Turn-on energy loss	$E_{\text{on}}$					25 150			0,3 0,46		mWs
Turn-off energy loss	$E_{\text{off}}$					25 150			1,52 2,14		
Input capacitance	$C_{\text{ies}}$								4620		
Output capacitance	$C_{\text{oss}}$								288		pF
Reverse transfer capacitance	$C_{\text{rss}}$								137		
Gate charge	$Q_G$		$\pm 15$	480	75	25			470		nC
Thermal resistance junction to heatsink	$R_{\text{th(j-s)}}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)							0,69		K/W
<b>Brake Inverse Diode</b>											
Diode forward voltage	$V_F$				10	25 150		1,2	1,78 1,76	2,1	V
Thermal resistance junction to heatsink	$R_{\text{th(j-s)}}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)							1,74		K/W
<b>Brake Diode</b>											
Diode forward voltage	$V_F$				30	25 150			1,62 1,58	2,1	V
Reverse leakage current	$I_r$			300		25				140	$\mu$ A
Peak reverse recovery current	$I_{RRM}$	$R_{\text{gon}} = 4 \Omega$	$\pm 15$	300	75	25 150			82 84		A
Reverse recovery time	$t_{rr}$					25 150			22,7 116		ns
Reverse recovered charge	$Q_{rr}$					25 150			2,14 3,82		$\mu$ C
Peak rate of fall of recovery current	$(di_{rf}/dt)_{\text{max}}$					25 150			10578 6820		A/ $\mu$ s
Reverse recovery energy	$E_{\text{rec}}$					25 150			0,52 0,97		mWs
Thermal resistance junction to heatsink	$R_{\text{th(j-s)}}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)							1,42		K/W
<b>Thermistor</b>											
Rated resistance	$R_{25}$					25		20,9	22	23,1	k $\Omega$
Deviation of $R_{100}$	$D_{R/R}$	$R_{100}=1486,1\Omega$				100			2,9		%
Power dissipation	$P$					25			210		mW
Power dissipation constant						25			2		mW/K

## Output Inverter

**figure 1.****Typical output characteristics**

$$I_C = f(V_{CE})$$

**At**

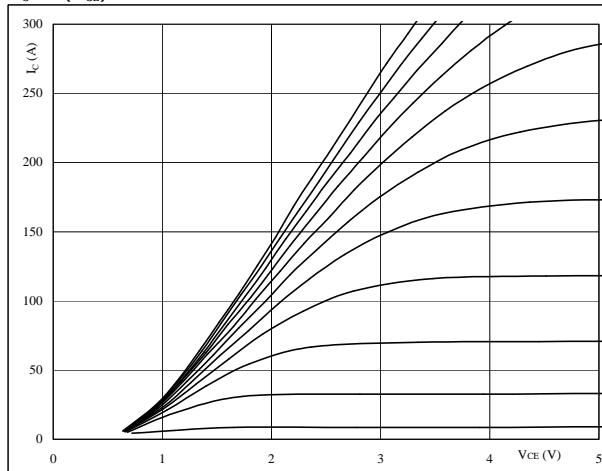
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

**IGBT****figure 2.****Typical output characteristics**

$$I_C = f(V_{CE})$$

**At**

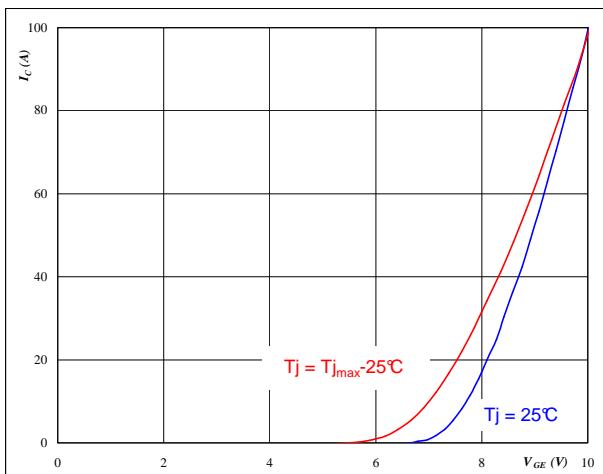
$$t_p = 250 \mu\text{s}$$

$$T_j = 150^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

**IGBT****figure 3.****IGBT****Typical transfer characteristics**

$$I_c = f(V_{GE})$$

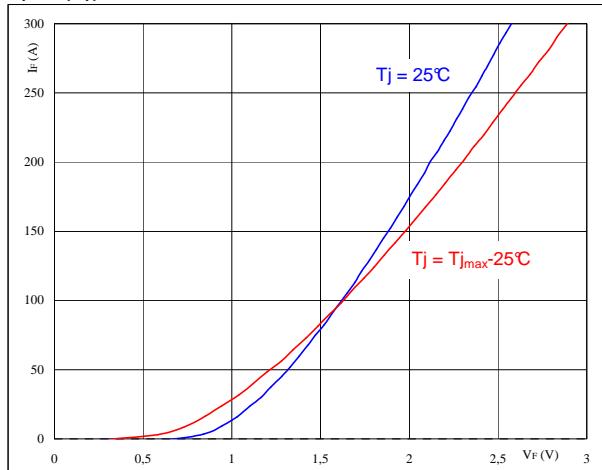
**At**

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

**FWD****Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

**At**

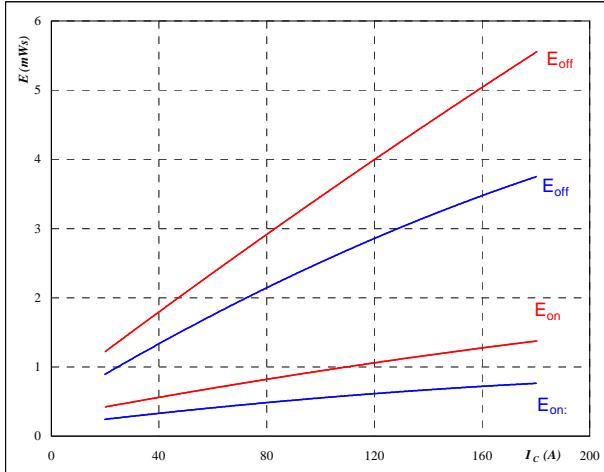
$$t_p = 250 \mu\text{s}$$

## Output Inverter

**figure 5.****IGBT**

**Typical switching energy losses  
as a function of collector current**

$$E = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

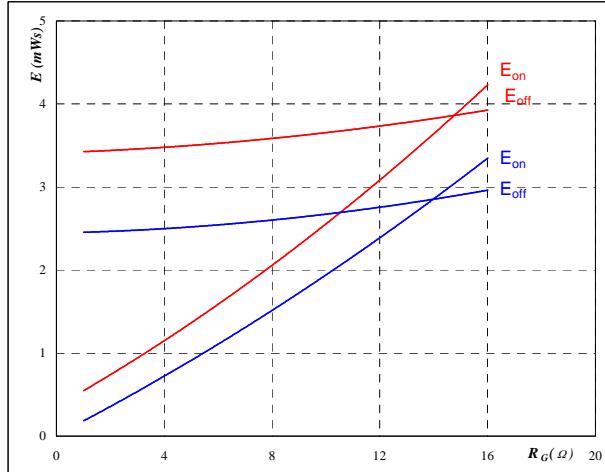
$$R_{gon} = 4 \quad \Omega$$

$$R_{goff} = 4 \quad \Omega$$

**figure 6.****IGBT**

**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

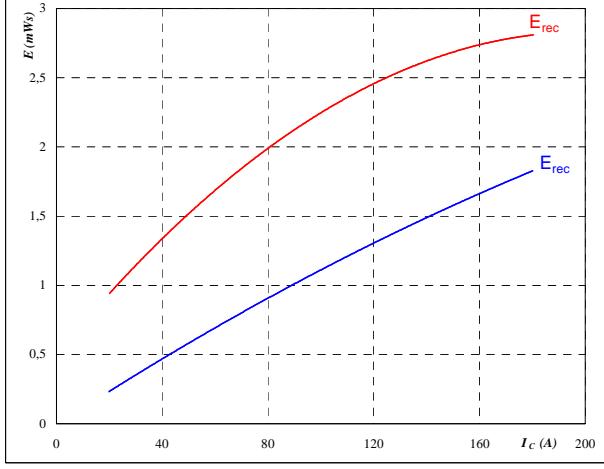
$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_c = 100 \quad \text{A}$$

**figure 7.****IGBT**

**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

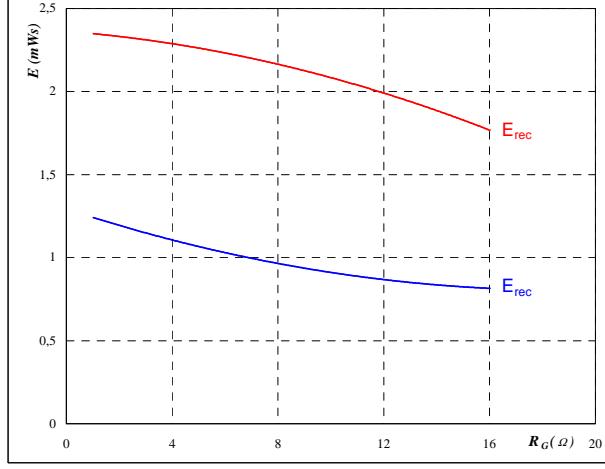
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**figure 8.****IGBT**

**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

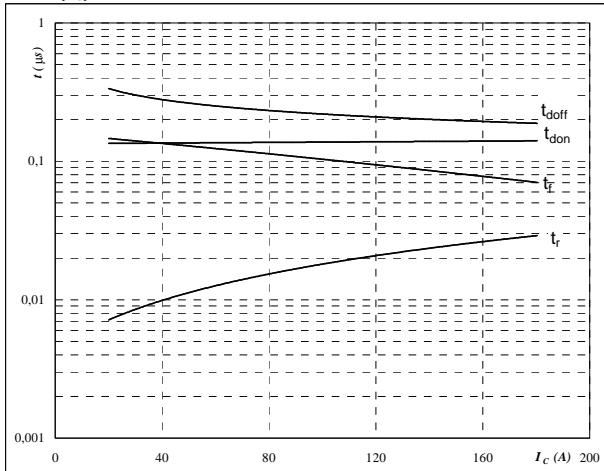
$$I_c = 100 \quad \text{A}$$

## Output Inverter

**figure 9.**

**Typical switching times as a function of collector current**

$$t = f(I_c)$$



With an inductive load at

$$T_j = 150 \text{ } ^\circ\text{C}$$

$$V_{CE} = 300 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

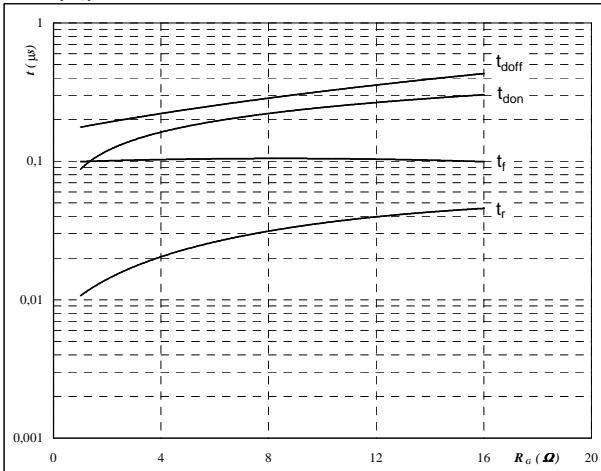
$$R_{gon} = 4 \text{ } \Omega$$

$$R_{goff} = 4 \text{ } \Omega$$

**IGBT****figure 10.**

**Typical switching times as a function of gate resistor**

$$t = f(R_g)$$



With an inductive load at

$$T_j = 150 \text{ } ^\circ\text{C}$$

$$V_{CE} = 300 \text{ V}$$

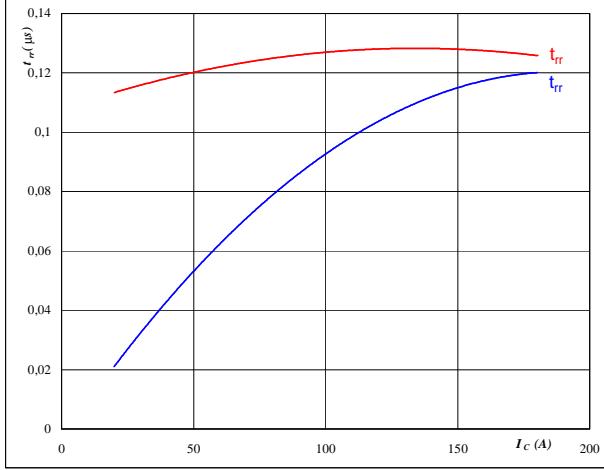
$$V_{GE} = \pm 15 \text{ V}$$

$$I_c = 100 \text{ A}$$

**IGBT****figure 11.****FWD**

**Typical reverse recovery time as a function of collector current**

$$t_{rr} = f(I_c)$$



**At**

$$T_j = 25/150 \text{ } ^\circ\text{C}$$

$$V_{CE} = 300 \text{ V}$$

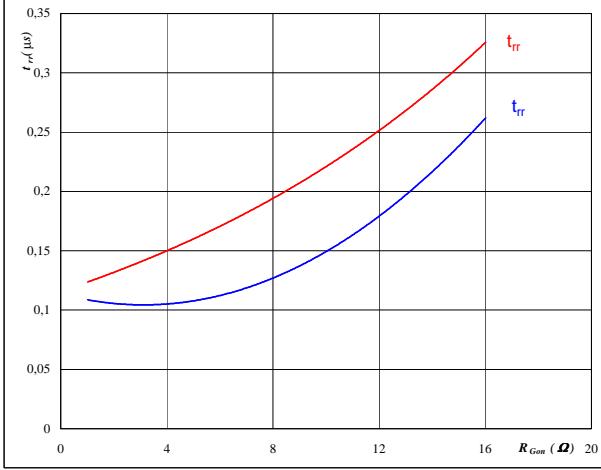
$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 12.****FWD**

**Typical reverse recovery time as a function of IGBT turn on gate resistor**

$$t_{rr} = f(R_{gon})$$



**At**

$$T_j = 25/150 \text{ } ^\circ\text{C}$$

$$V_R = 300 \text{ V}$$

$$I_F = 100 \text{ A}$$

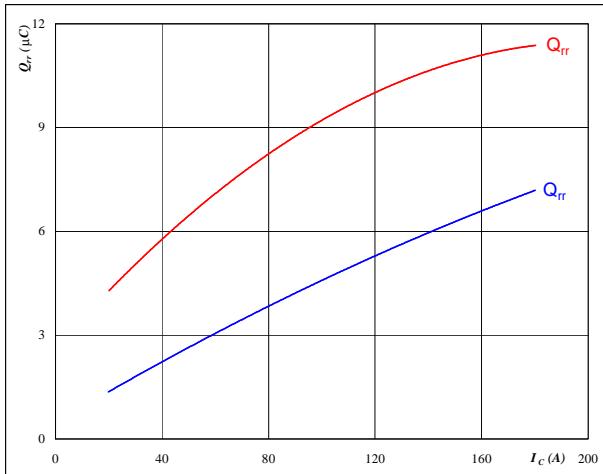
$$V_{GE} = \pm 15 \text{ V}$$

## Output Inverter

**figure 13.****FWD**

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_c)$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad {}^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

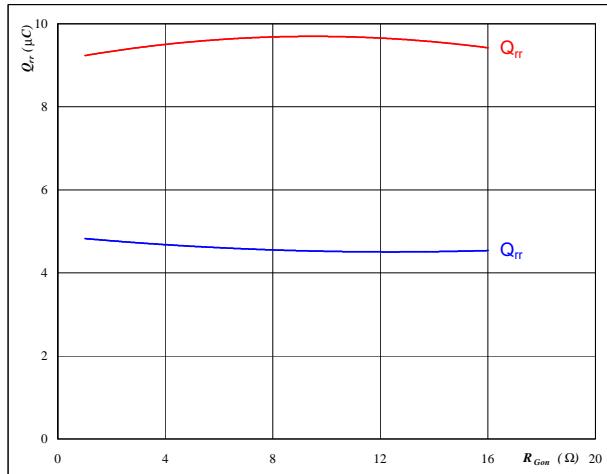
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**figure 14.****FWD**

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad {}^\circ\text{C}$$

$$V_R = 300 \quad \text{V}$$

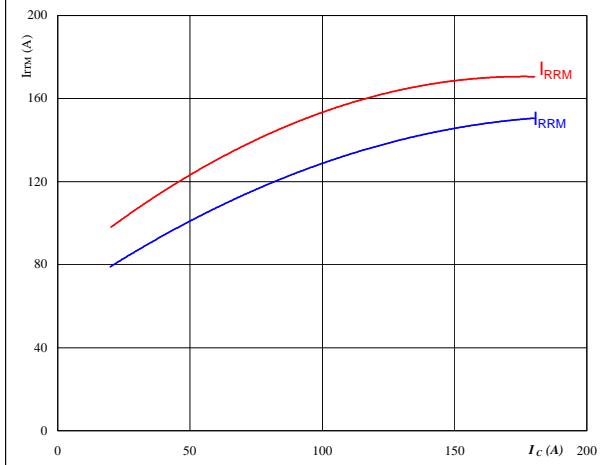
$$I_F = 100 \quad \text{A}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

**figure 15.****FWD**

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_c)$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad {}^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

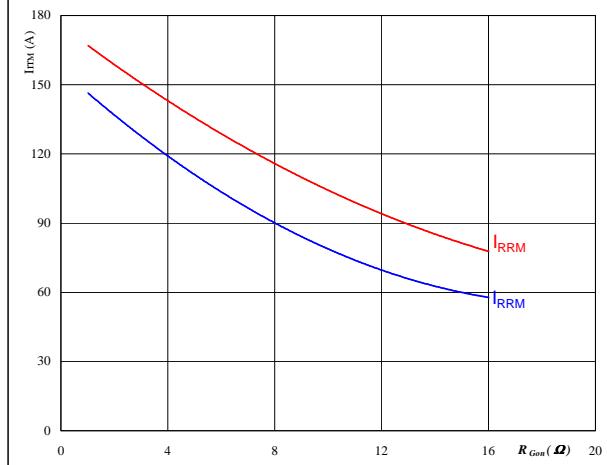
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**figure 16.****FWD**

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad {}^\circ\text{C}$$

$$V_R = 300 \quad \text{V}$$

$$I_F = 100 \quad \text{A}$$

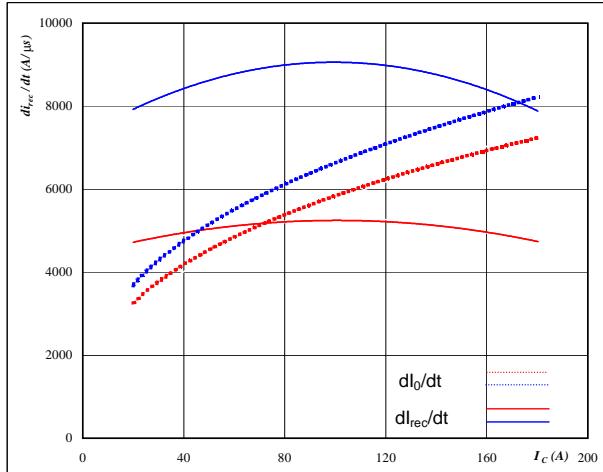
$$V_{GE} = \pm 15 \quad \text{V}$$

# Output Inverter

**figure 17.****FWD**

Typical rate of fall of forward  
and reverse recovery current as a  
function of collector current

$$dI_0/dt, dI_{rec}/dt = f(I_c)$$

**At**

$$T_j = 25/150 \quad {}^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

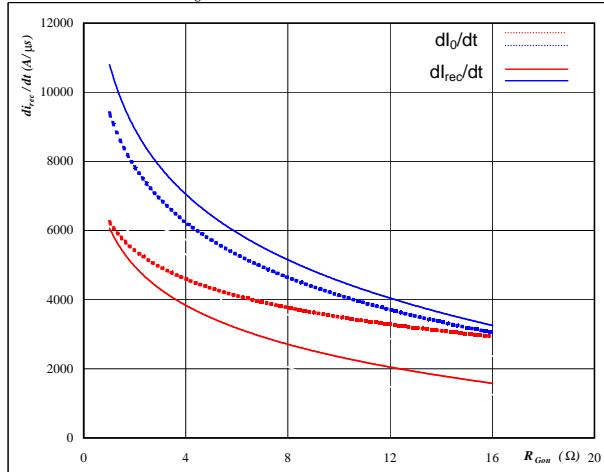
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**figure 18.****FWD**

Typical rate of fall of forward  
and reverse recovery current as a  
function of IGBT turn on gate resistor

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

**At**

$$T_j = 25/150 \quad {}^\circ\text{C}$$

$$V_R = 300 \quad \text{V}$$

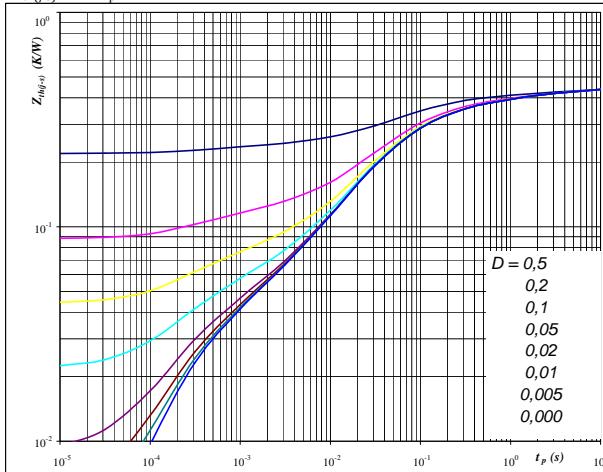
$$I_F = 100 \quad \text{A}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

**figure 19.****IGBT**

IGBT transient thermal impedance  
as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 0,44 \quad \text{K/W}$$

Single device heated

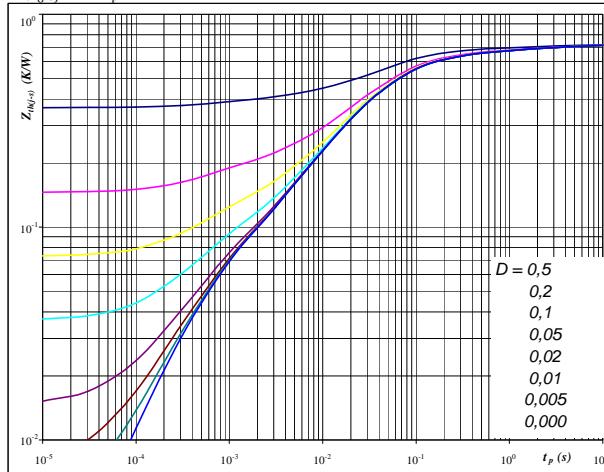
IGBT thermal model values

R (K/W)	Tau (s)
5,33E-02	3,13E+00
6,35E-02	4,55E-01
1,49E-01	8,61E-02
1,20E-01	2,32E-02
2,69E-02	2,62E-03
2,67E-02	2,83E-04

**figure 20.****FWD**

FWD transient thermal impedance  
as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 0,73 \quad \text{K/W}$$

Single device heated

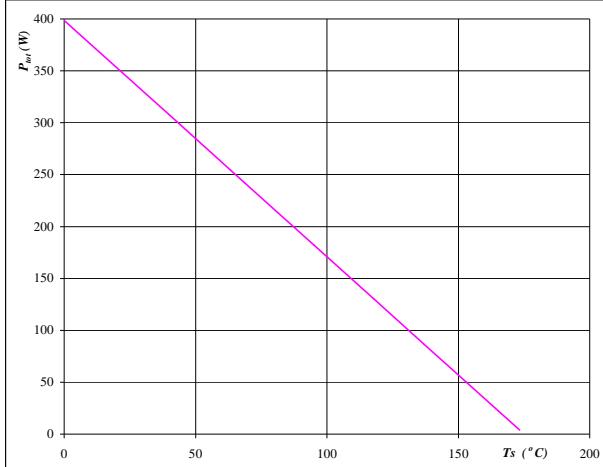
FWD thermal model values

R (K/W)	Tau (s)
4,08E-02	9,16E+00
5,69E-02	8,67E-01
1,69E-01	1,19E-01
3,37E-01	2,86E-02
7,44E-02	4,99E-03
5,00E-02	5,33E-04

## Output Inverter

**figure 21.**
**IGBT**
**Power dissipation as a  
function of heatsink temperature**

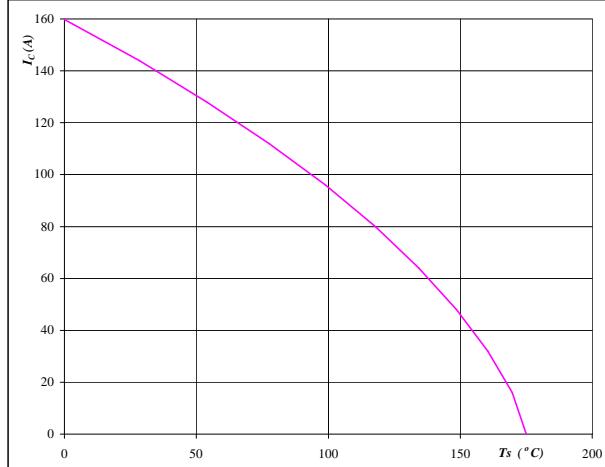
$$P_{\text{tot}} = f(T_s)$$


**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**figure 22.**
**IGBT**
**Collector current as a  
function of heatsink temperature**

$$I_C = f(T_s)$$

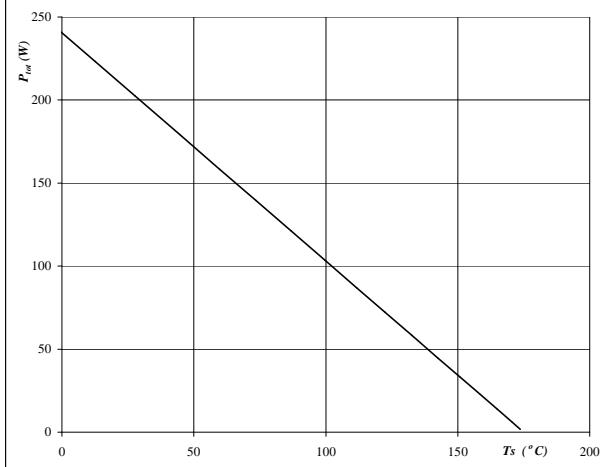

**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

$$V_{GE} = 15 \text{ V}$$

**figure 23.**
**FWD**
**Power dissipation as a  
function of heatsink temperature**

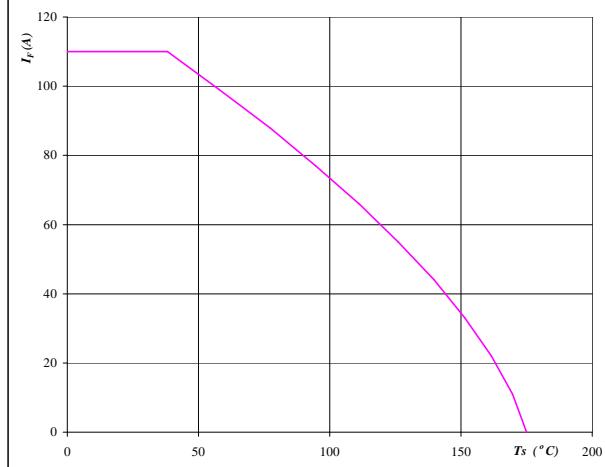
$$P_{\text{tot}} = f(T_s)$$


**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**figure 24.**
**FWD**
**Forward current as a  
function of heatsink temperature**

$$I_F = f(T_s)$$


**At**

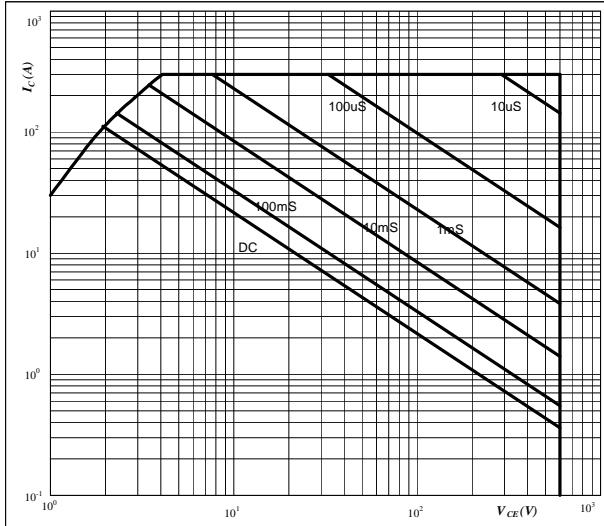
$$T_j = 175 \text{ } ^\circ\text{C}$$

## Output Inverter

**figure 25.**

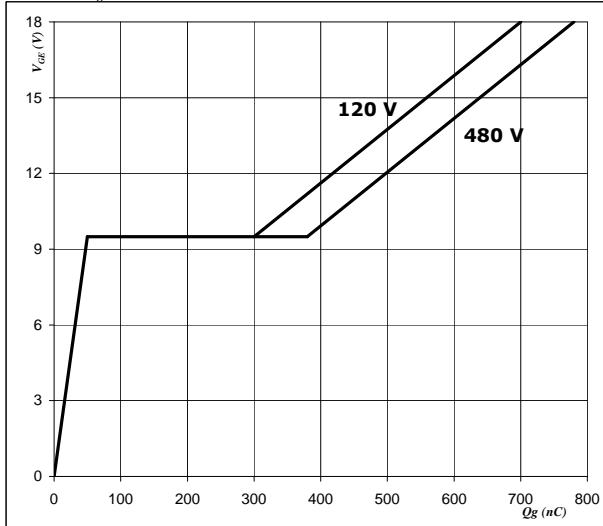
**Safe operating area as a function  
of collector-emitter voltage**

$$I_C = f(V_{CE})$$

**IGBT****figure 26.**

**Gate voltage vs Gate charge**

$$V_{GE} = f(Q_g)$$

**IGBT****At**

$D =$  single pulse

$T_s =$  80  $^{\circ}\text{C}$

$V_{GE} = \pm 15$  V

$T_j = T_{j\max}$

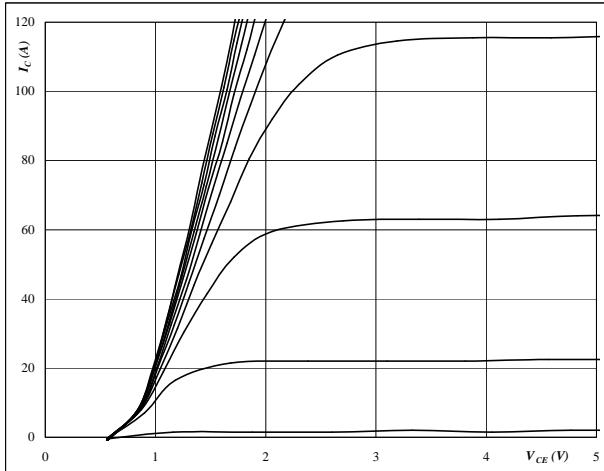
**At**

$I_C = 100$  A

# Brake

**figure 1.**
**Typical output characteristics**

$$I_C = f(V_{CE})$$


**At**

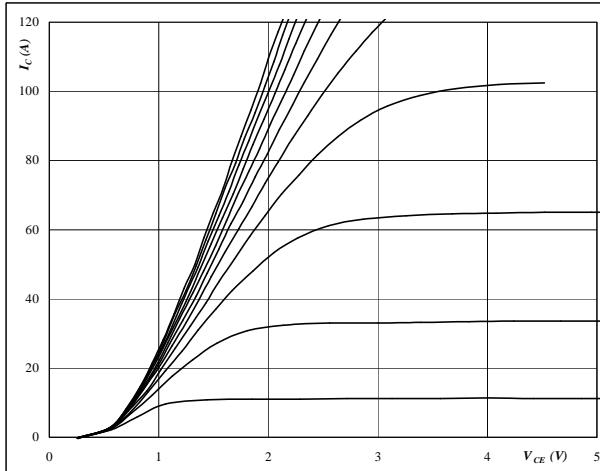
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

**IGBT**
**figure 2.**
**Typical output characteristics**

$$I_C = f(V_{CE})$$


**At**

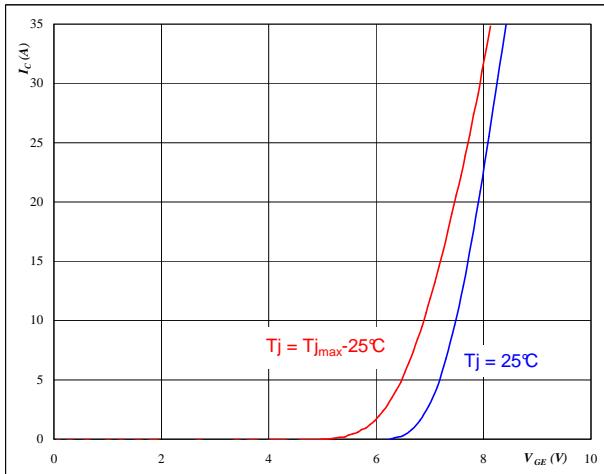
$$t_p = 250 \mu\text{s}$$

$$T_j = 150^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

**IGBT**
**figure 3.**
**IGBT**
**Typical transfer characteristics**

$$I_C = f(V_{GE})$$

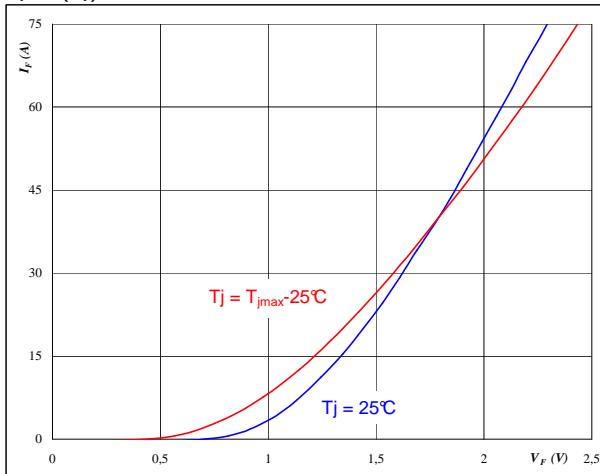

**At**

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

**figure 4.**
**FWD**
**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

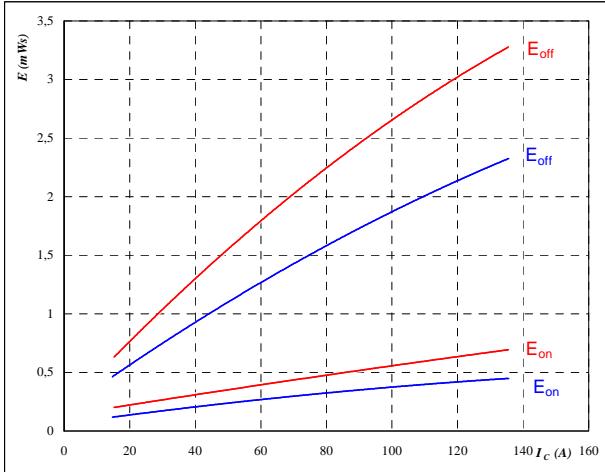

**At**

$$t_p = 250 \mu\text{s}$$

# Brake

**figure 5.**
**IGBT**
**Typical switching energy losses  
as a function of collector current**

$$E = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

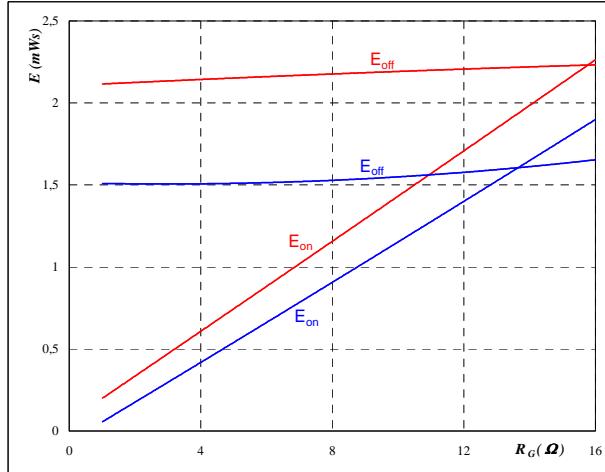
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

$$R_{goff} = 4 \quad \Omega$$

**figure 6.**
**IGBT**
**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

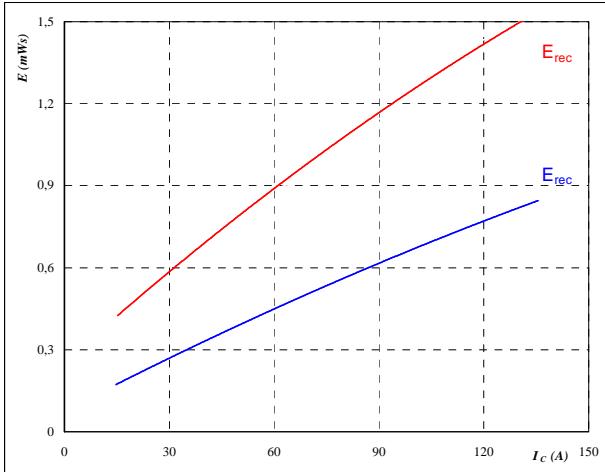
$$V_{CE} = 300 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_c = 75 \quad \text{A}$$

**figure 7.**
**IGBT**
**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

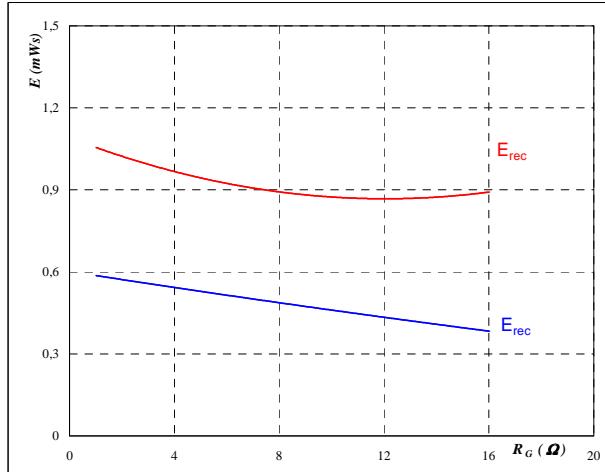
$$V_{CE} = 300 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**figure 8.**
**IGBT**
**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 300 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

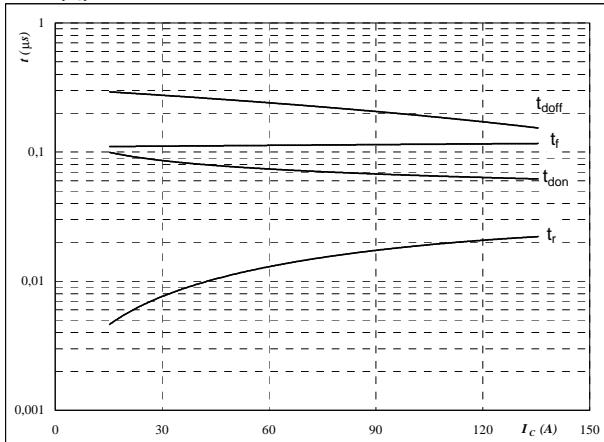
$$I_c = 75 \quad \text{A}$$

# Brake

**figure 9.**

**Typical switching times as a function of collector current**

$$t = f(I_C)$$



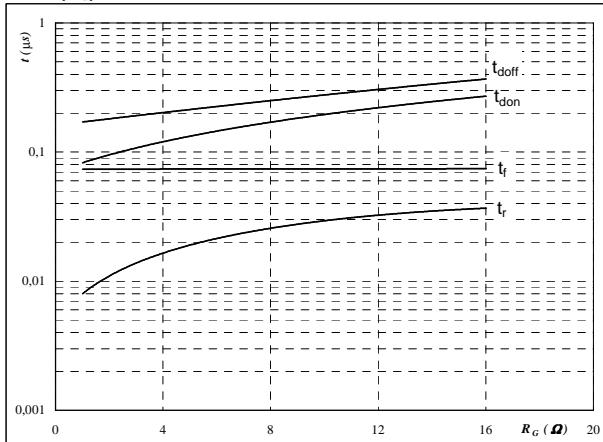
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

**IGBT****figure 10.**

**Typical switching times as a function of gate resistor**

$$t = f(R_G)$$



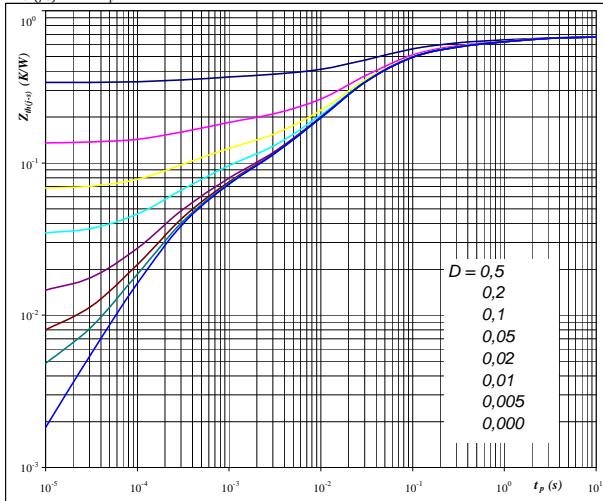
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_C =$	75	A

**figure 11.****IGBT**

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$



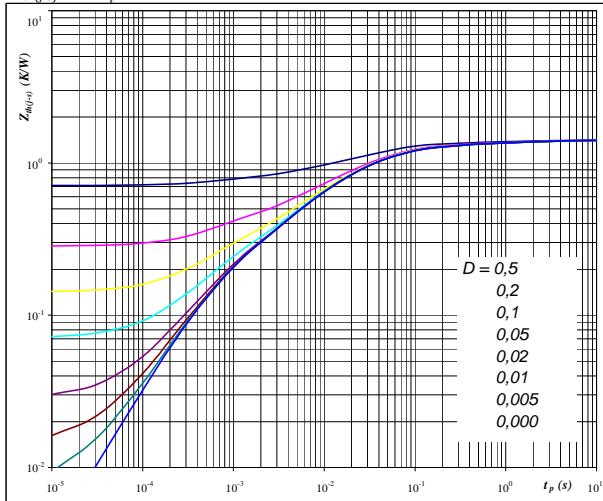
**At**

$$\begin{aligned} D &= t_p / T \\ R_{th(j-s)} &= 0.67 \quad \text{K/W} \end{aligned}$$

**figure 12.****IGBT**

**FWD transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$



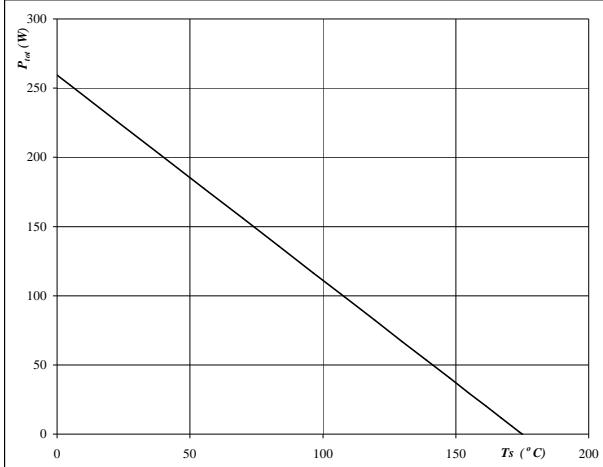
**At**

$$\begin{aligned} D &= t_p / T \\ R_{th(j-s)} &= 1.42 \quad \text{K/W} \end{aligned}$$

# Brake

**figure 13.**
**IGBT**
**Power dissipation as a  
function of heatsink temperature**

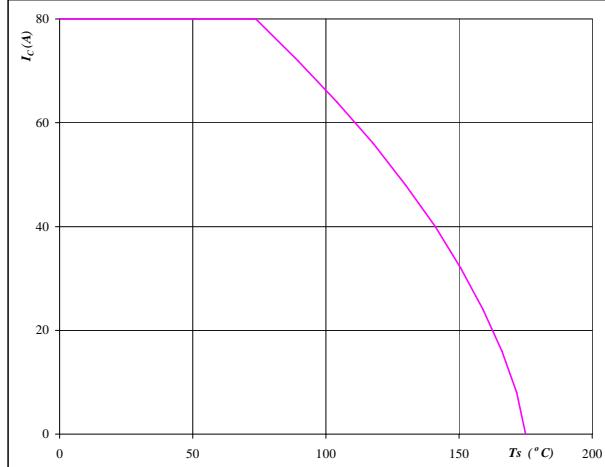
$$P_{\text{tot}} = f(T_s)$$


**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**figure 14.**
**IGBT**
**Collector current as a  
function of heatsink temperature**

$$I_C = f(T_s)$$

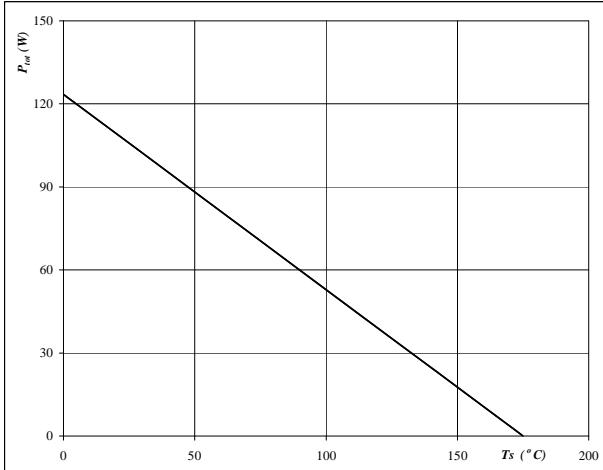

**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

$$V_{GE} = 15 \text{ V}$$

**figure 15.**
**FWD**
**Power dissipation as a  
function of heatsink temperature**

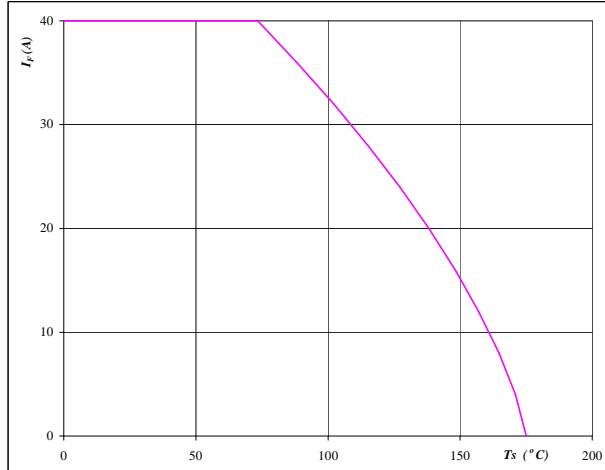
$$P_{\text{tot}} = f(T_s)$$


**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**figure 16.**
**FWD**
**Forward current as a  
function of heatsink temperature**

$$I_F = f(T_s)$$


**At**

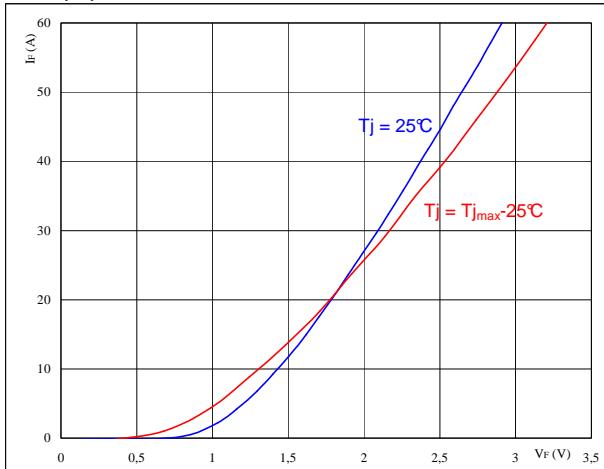
$$T_j = 175 \text{ } ^\circ\text{C}$$

# Brake Inverse Diode

**figure 1.****Brake inverse diode**

**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

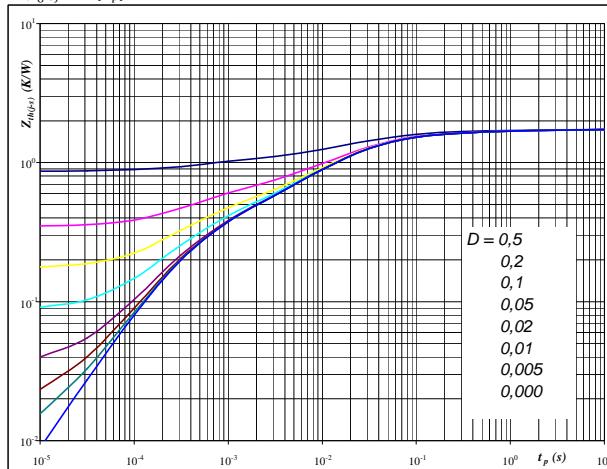
**At**

$$t_p = 250 \mu\text{s}$$

**figure 2.****Brake inverse diode**

**Diode transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

**At**

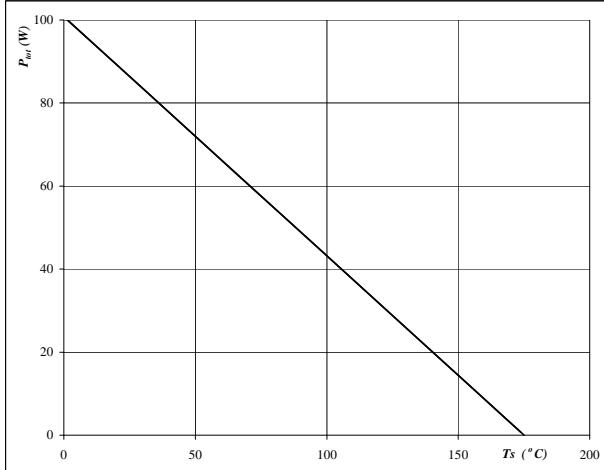
$$D = t_p / T$$

$$R_{th(j-s)} = 1,74 \text{ K/W}$$

**figure 3.****Brake inverse diode**

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

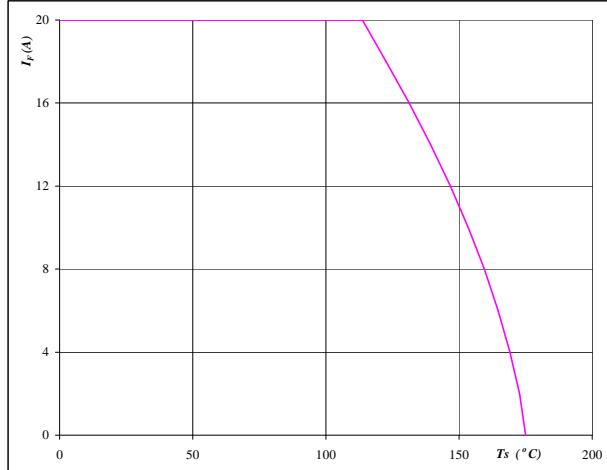
**At**

$$T_j = 175 \text{ °C}$$

**figure 4.****Brake inverse diode**

**Forward current as a function of heatsink temperature**

$$I_F = f(T_s)$$

**At**

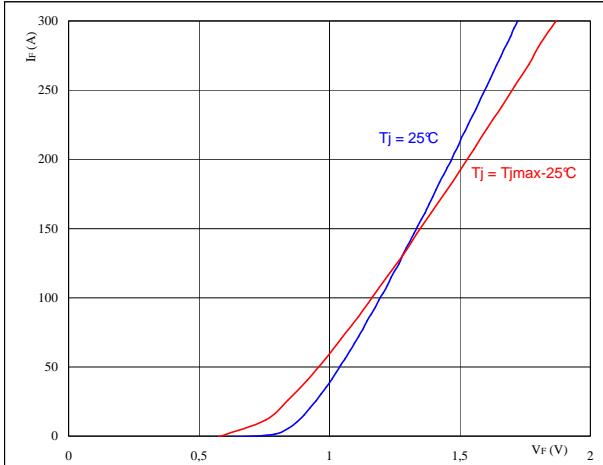
$$T_j = 175 \text{ °C}$$

# Input Rectifier Bridge

**figure 1.****Rectifier Diode**

**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

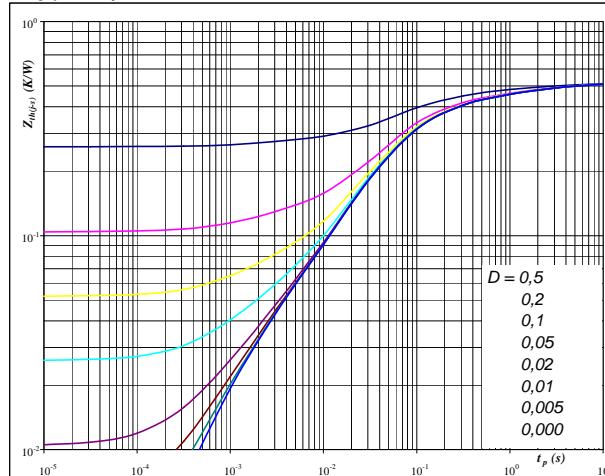
**At**

$$t_p = 250 \mu\text{s}$$

**figure 2.****Rectifier Diode**

**Diode transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

**At**

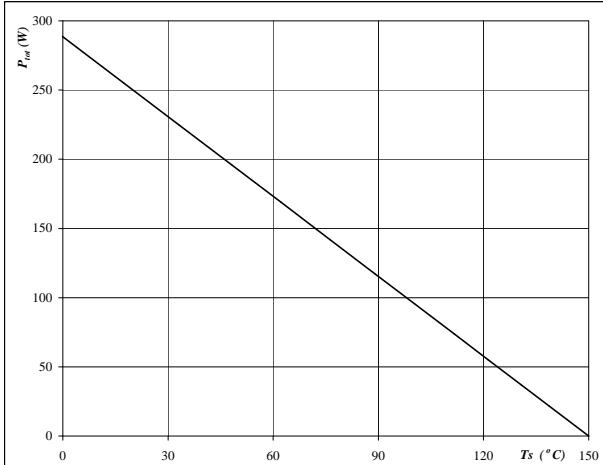
$$D = t_p / T$$

$$R_{th(j-s)} = 0,52 \text{ K/W}$$

**figure 3.****Rectifier Diode**

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

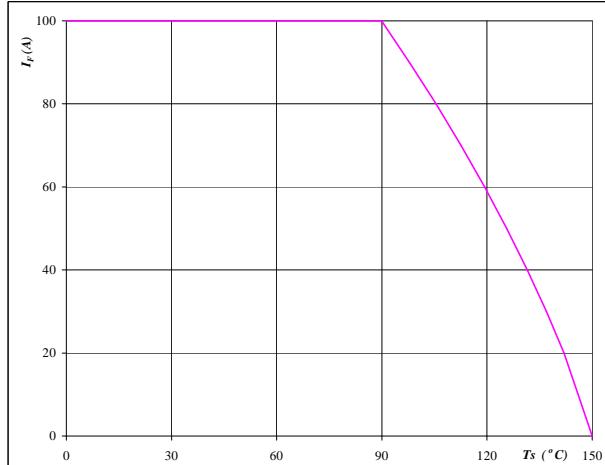
**At**

$$T_j = 150 ^\circ\text{C}$$

**figure 4.****Rectifier Diode**

**Forward current as a function of heatsink temperature**

$$I_F = f(T_s)$$

**At**

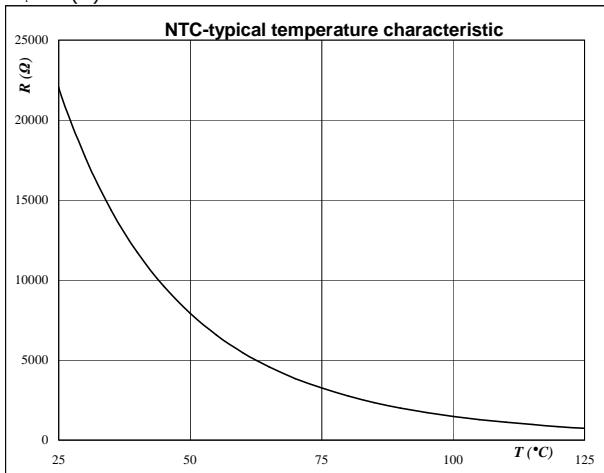
$$T_j = 150 ^\circ\text{C}$$

## Thermistor

**figure 1.** Thermistor

Typical NTC characteristic  
as a function of temperature

$$R_T = f(T)$$



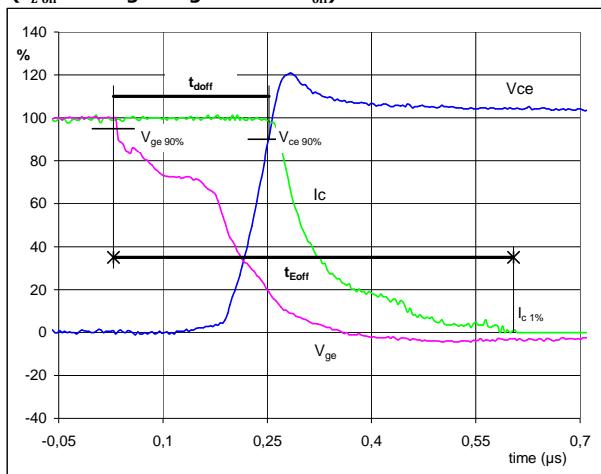
## Switching Definitions Output Inverter

**General conditions**

$T_j$	= 150 °C
$R_{gon}$	= 4 Ω
$R_{goff}$	= 4 Ω

**figure 1.**

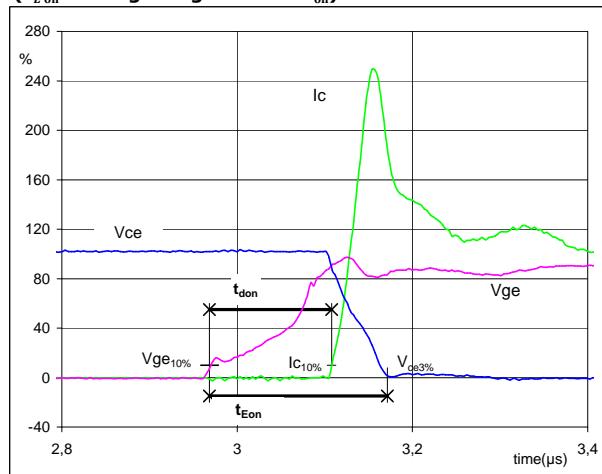
**IGBT**  
**Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$**   
( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%) = -15$  V  
 $V_{GE}(100\%) = 15$  V  
 $V_C(100\%) = 300$  V  
 $I_C(100\%) = 100$  A  
 $t_{doff} = 0,22$  μs  
 $t_{Eoff} = 0,58$  μs

**figure 2.**

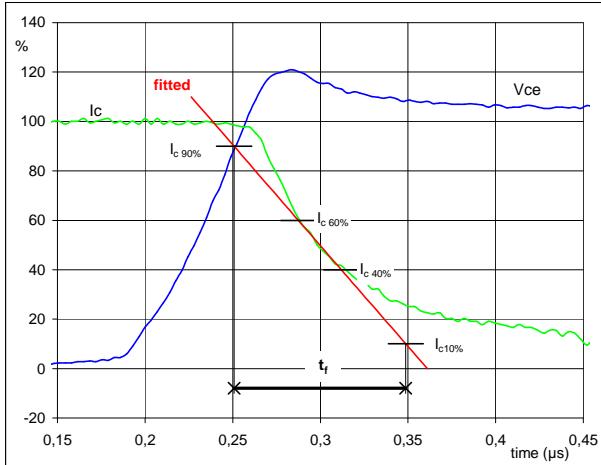
**IGBT**  
**Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$**   
( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(0\%) = -15$  V  
 $V_{GE}(100\%) = 15$  V  
 $V_C(100\%) = 300$  V  
 $I_C(100\%) = 100$  A  
 $t_{don} = 0,14$  μs  
 $t_{Eon} = 0,20$  μs

**figure 3.**

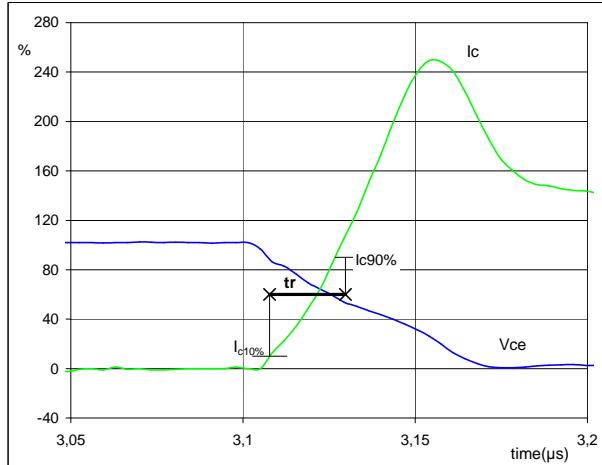
**IGBT**  
**Turn-off Switching Waveforms & definition of  $t_f$**



$V_C(100\%) = 300$  V  
 $I_C(100\%) = 100$  A  
 $t_f = 0,10$  μs

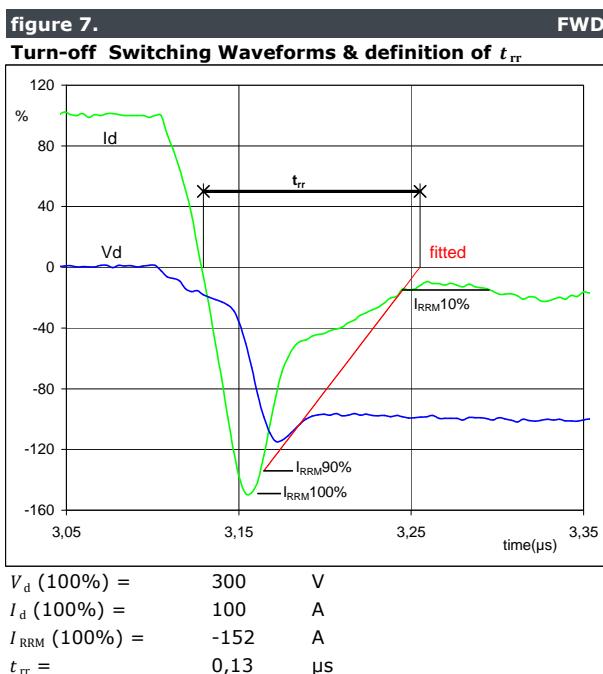
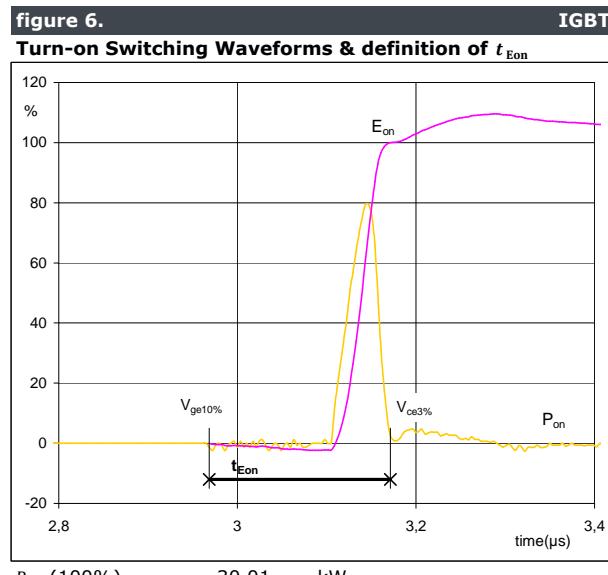
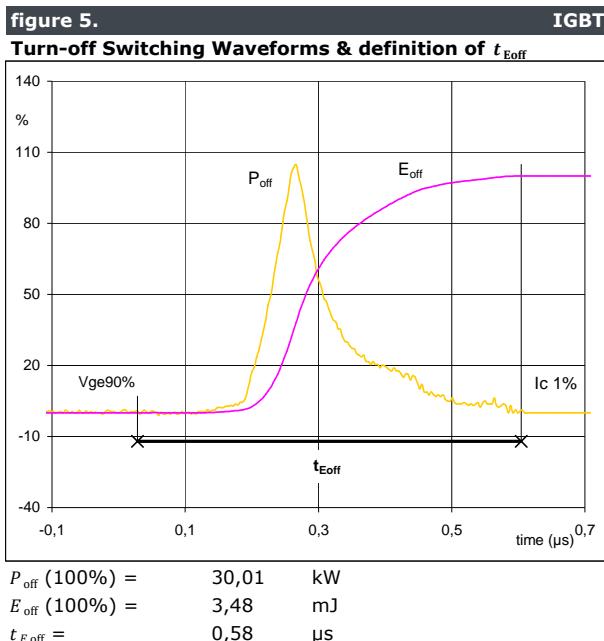
**figure 4.**

**IGBT**  
**Turn-on Switching Waveforms & definition of  $t_r$**



$V_C(100\%) = 300$  V  
 $I_C(100\%) = 100$  A  
 $t_r = 0,02$  μs

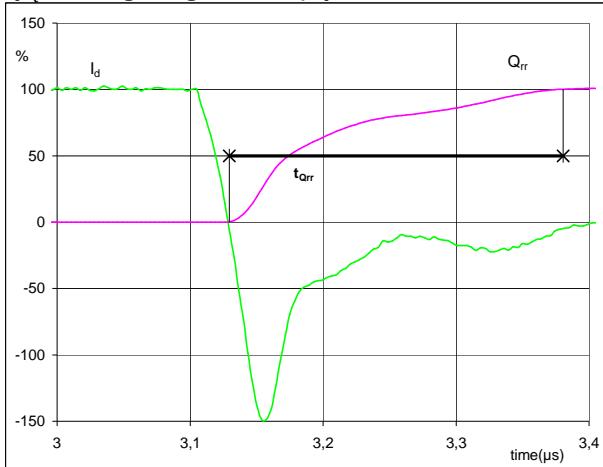
## Switching Definitions Output Inverter



## Switching Definitions Output Inverter

**figure 8.****FWD**

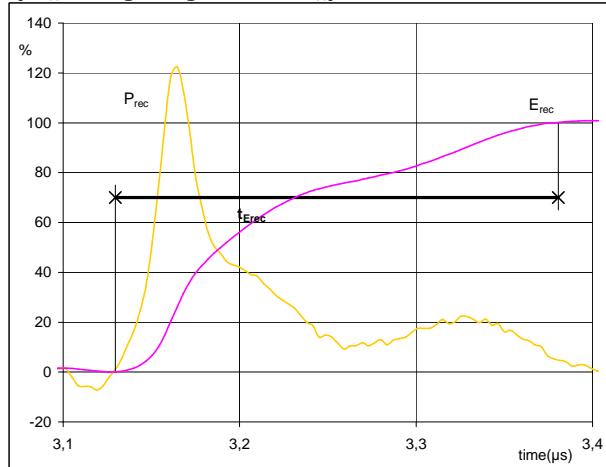
**Turn-on Switching Waveforms & definition of  $t_{Qrr}$**   
 $(t_{Qrr} = \text{integrating time for } Q_{rr})$



$I_d$  (100%) = 100 A  
 $Q_{rr}$  (100%) = 9,20  $\mu\text{C}$   
 $t_{Qint}$  = 0,25  $\mu\text{s}$

**figure 9.****FWD**

**Turn-on Switching Waveforms & definition of  $t_{Erec}$**   
 $(t_{Erec} = \text{integrating time for } E_{rec})$

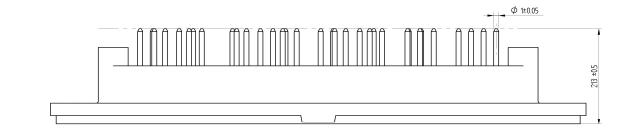
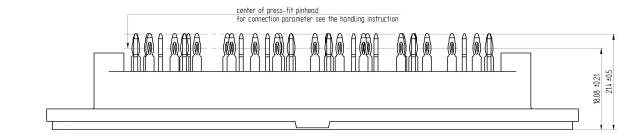
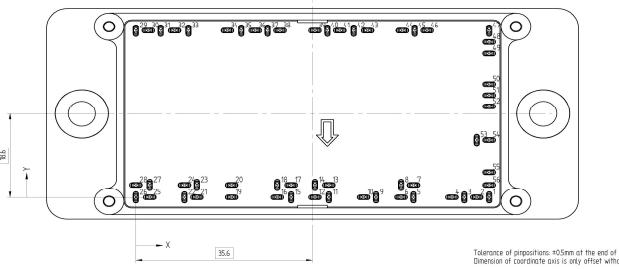


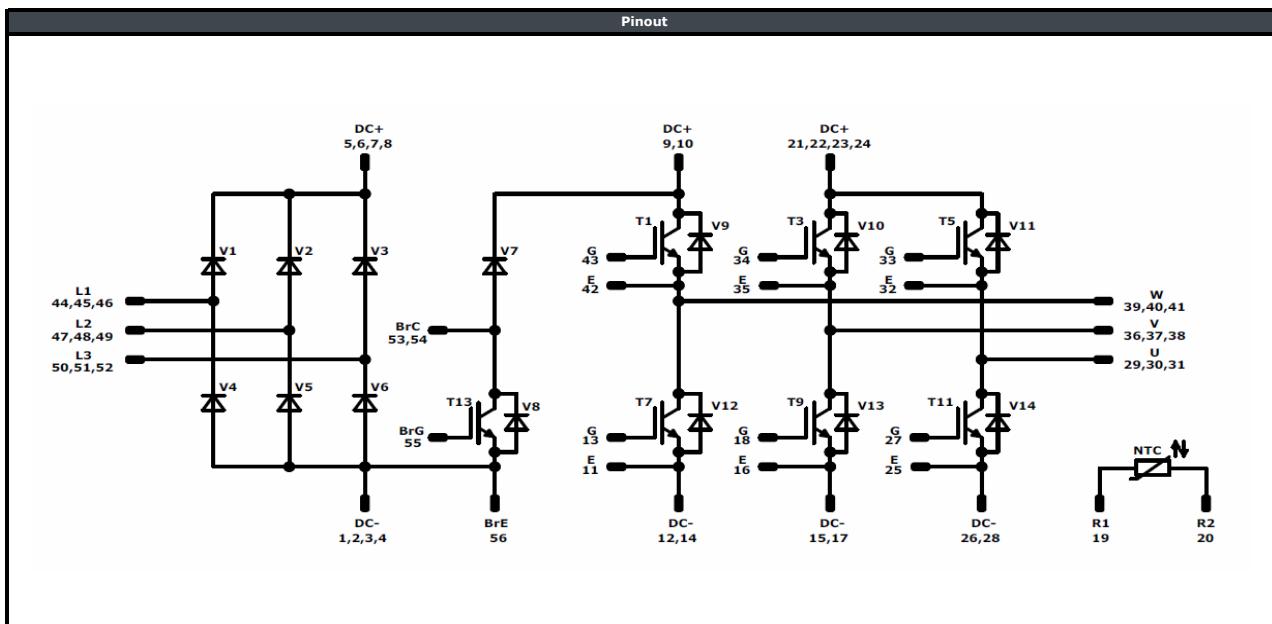
$P_{rec}$  (100%) = 30,01 kW  
 $E_{rec}$  (100%) = 2,25 mJ  
 $t_{Erec}$  = 0,25  $\mu\text{s}$

## Ordering Code and Marking - Outline - Pinout

Ordering Code & Marking							
Version	Ordering Code		in DataMatrix as		in packaging barcode as		
without thermal paste with solder pins	V23990-P765-A-PM		P765-A		P765-A		
with thermal paste with solder pins	V23990-P765-A-/3/-PM		P765-A-/3/		P765-A-/3/		
without thermal paste with Press-fit pins	V23990-P765-AY-PM		P765-AY		P765-AY		
with thermal paste with Press-fit pins	V23990-P765-AY-/3/-PM		P765-AY-/3/		P765-AY-/3/		
VIN WWYY NNNNNNVV UL LLLLL SSSS			Text	Name	Date code	UL & Vinco	Lot
				NN-NNNNNNNNNNNNN-TTTTTTV	WWYY	UL Vinco	LLLLL
			Datamatrix	Type&Ver	Lot number	Serial	Date code
				TTTTTTVV	LLLLL	SSSS	WWYY

Pin table [mm]								Outline							
Pin	Func	X	Y	Pin	Func	X	Y								
1	DC-	71,2	0	29	U	0	37,2								
2	DC-	68,7	0	30	U	2,5	37,2								
3	DC-	66,2	0	31	U	5	37,2								
4	DC-	63,7	0	32	E	7,8	37,2								
5	DC+	55,95	0	33	G	10,6	37,2								
6	DC+	53,45	0	34	G	18,45	37,2								
7	DC+	55,95	2,8	35	E	21,25	37,2								
8	DC+	53,45	2,8	36	V	24,05	37,2								
9	DC+	48,4	0	37	V	26,55	37,2								
10	DC+	45,9	0	38	V	29,05	37,2								
11	E	38,9	0	39	W	36,1	37,2								
12	DC-	36,1	0	40	W	38,6	37,2								
13	G	38,9	2,8	41	W	41,1	37,2								
14	DC-	36,1	2,8	42	E	43,9	37,2								
15	DC-	31,3	0	43	G	46,7	37,2								
16	E	28,5	0	44	L1	53,7	37,2								
17	DC-	31,3	2,8	45	L1	56,2	37,2								
18	G	28,5	2,8	46	L1	58,7	37,2								
19	R2	19,3	0	47	L2	71,2	37,2								
20	R1	19,3	2,8	48	L2	71,2	34,7								
21	DC+	12,3	0	49	L2	71,2	32,2								
22	DC+	9,8	0	50	L3	71,2	25,2								
23	DC+	12,3	2,8	51	L3	71,2	22,7								
24	DC+	9,8	2,8	52	L3	71,2	20,2								
25	E	2,8	0	53	BrC	71,2	12,8								
26	DC-	0	0	54	BrC	68,7	12,8								
27	G	2,8	2,8	55	BrG	71,2	5,6								
28	DC-	0	2,8	56	BrE	71,2	2,8								



<b>Identification</b>					
ID	Component	Voltage	Current	Function	Comment
T1,T3,T5,T7,T9,T11	IGBT	600 V	100 A	Inverter Switch	
V9-V14	FWD	600 V	50 A	Inverter Diode	
V1-V6	Rectifier Diode	1600 V	75 A	Rectifier Diode	
T13	IGBT	600 V	75A	Brake Switch	
V7	FWD	600 V	30 A	Brake Diode	
V8	FWD	600 V	20 A	Brake Inverse Diode	
NTC	Thermistor			Thermistor	



Vincotech

V23990-P765-A-PM

V23990-P765-AY-PM

datasheet

Packaging instruction		>SPQ	Standard	<SPQ	Sample
Standard packaging quantity (SPQ)	36				

Handling instruction
Handling instructions for <i>flow</i> 2 packages see <a href="http://vincotech.com">vincotech.com</a> website.

Package data
Package data for <i>flow</i> 2 packages see <a href="http://vincotech.com">vincotech.com</a> website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see <a href="http://vincotech.com">vincotech.com</a> website. 

Document No.:	Date:	Modification:	Pages
V23990-P765-Ax-D8-14	24 Jan. 2019	flow2 frame modification	1,22

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.